

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

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SURFACE MOUNT SWITCHING DIODE ARRAY

Features

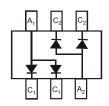
- Fast Switching Speed
- Ultra-Small Surface Mount Package
- For General Purpose Switching Applications
- High Conductance
- Two "BAW56" Circuits In One Package
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standard for High Reliability

Mechanical Data

- Case: SOT363
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020D
- Terminals: Solderable per MIL-STD-202, Method 208 63
- Lead Free Plating (Matte Tin Finish annealed over Alloy 42 leadframe).
- Polarity: See Diagram
- Weight: 0.006 grams (approximate)



Top View



Top View Internal Schematic

Ordering Information (Note 4)

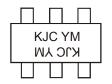
| Part Number | Case | Packaging | | |
|--------------|--------|------------------|--|--|
| BAW56DW-7-F | SOT363 | 3000/Tape & Reel | | |
| BAW56DWQ-7-F | SOT363 | 3000/Tape & Reel | | |

SOT363

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http"//www.diodes.com/products/packages.html.

Marking Information



KJC = Product Type Marking Code YM = Date Code Marking Y = Year ex: N = 2002 M = Month ex: 9 = September

Date Code Key

| Year | 2002 | 2003 | | 2008 | 2009 | 2010 | 2011 | 2012 | 2013 | 2014 | 2015 | 2016 | 2017 | 2018 |
|-------|------|------|-----|------|------|------|------|------|------|------|------|------|------|------|
| Code | Ν | Р | | V | W | Х | Υ | Z | Α | В | С | D | Е | F |
| Month | Jan | Fe | b N | /lar | Apr | May | Jun | Jul | Aug | Se | ep . | Oct | Nov | Dec |
| Code | 1 | 2 | | 3 | 4 | 5 | 6 | 7 | 8 | 6 |) | 0 | N | D |



| Characteristic | | Symbol | Value | Unit |
|--|---------------------------|--|------------|------|
| Non-Repetitive Peak Reverse Voltage | | V_{RM} | 100 | V |
| Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage | | V _{RRM} V _{RWM} V _R | 75 | V |
| RMS Reverse Voltage | | V _{R(RMS)} | 53 | V |
| Forward Continuous Current | (Note 5) | I _{FM} | 300 | mA |
| Average Rectified Output Current | (Note 5) | lo | 150 | mA |
| Non-Repetitive Peak Forward Surge Current | @ t = 1.0µs @ t = 1.0s | I _{FSM} | 2.0 1.0 | А |

Thermal Characteristics

| Characteristic | | Symbol | Value | Unit |
|--|----------|---------------|-------------|------|
| Power Dissipation | (Note 5) | P_{D} | 200 | mW |
| Thermal Resistance Junction to Ambient Air | (Note 5) | $R_{	hetaJA}$ | 625 | °C/W |
| Operating and Storage Temperature Range | | T_J,T_STG | -65 to +150 | °C |

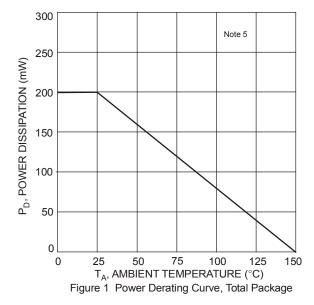
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

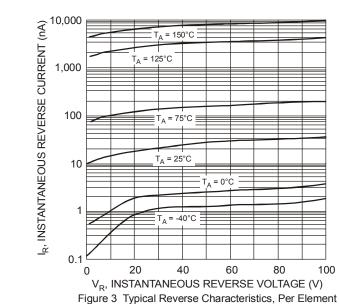
| Characteristic | | Symbol | Min | Max | Unit | Test Condition |
|---------------------------|----------|-----------------|-----|-------------------------------|----------------------|--|
| Reverse Breakdown Voltage | (Note 6) | $V_{(BR)R}$ | 75 | _ | V | $I_R = 2.5 \mu A$ |
| Forward Voltage | | V _F | _ | 0.715 0.855 1.0 1.25 | V | I _F = 1.0mA I _F = 10mA I _F = 50mA I _F = 150mA |
| Reverse Current | (Note 6) | I _R | _ | 2.5 50 30 25 | μΑ μΑ μΑ nA | V _R = 75V V _R = 75V, T _J = +150°C V _R = 25V, T _J = +150°C V _R = 20V |
| Total Capacitance | | Ст | _ | 2.0 | pF | V _R = 0, f = 1.0MHz |
| Reverse Recovery Time | | t _{rr} | _ | 4.0 | ns | $I_F = I_R = 10 \text{mA},$ $I_{rr} = 0.1 \text{ x } I_R, R_L = 100 \Omega$ |

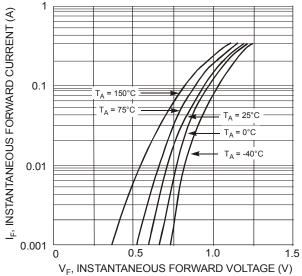
Notes:

^{5.} Device mounted on FR-4 PC board with recommended pad layout, which can be found on our website at http://www.diodes.com/datasheets/ap02001.pdf. 6. Short duration pulse test used to minimize self-heating effect.









V_F, INSTANTANEOUS FORWARD VOLTAGE (V) Figure 2 Typical Forward Characteristics, Per Element

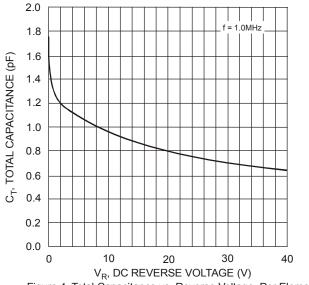
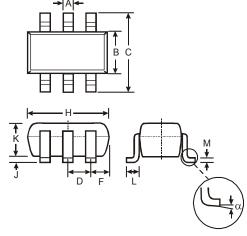


Figure 4 Total Capacitance vs. Reverse Voltage, Per Element

Package Outline Dimensions

Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.

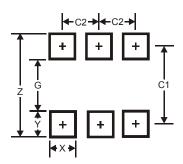


| | SOT363 | | | | | | | |
|-----|----------------------|------|------|--|--|--|--|--|
| Dim | Min Max Typ | | | | | | | |
| Α | 0.10 | 0.30 | 0.25 | | | | | |
| В | 1.15 | 1.35 | 1.30 | | | | | |
| С | 2.00 | 2.20 | 2.10 | | | | | |
| D | 0.65 Typ | | | | | | | |
| F | 0.40 0.45 0.425 | | | | | | | |
| Н | 1.80 2.20 2.15 | | | | | | | |
| J | 0 0.10 0.05 | | | | | | | |
| K | 0.90 1.00 1.00 | | | | | | | |
| L | 0.25 0.40 0.30 | | | | | | | |
| М | 0.10 | 0.22 | 0.11 | | | | | |
| α | 0° | 8° | - | | | | | |
| All | All Dimensions in mm | | | | | | | |



Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



| Dimensions | Value (in mm) |
|------------|---------------|
| Z | 2.5 |
| G | 1.3 |
| Х | 0.42 |
| Υ | 0.6 |
| C1 | 1.9 |
| C2 | 0.65 |

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